HVU307

Variable Capacitance Diode for VHF tuner

HITACHI

ADE-208-069E (Z)
Rev 5
Nov. 1998

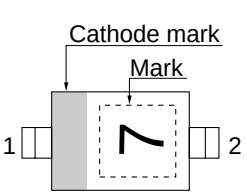
Features

- High capacitance ratio (n=12.0min)
- Low series resistance. (rs=0.85Ωmax)
- Ultra small Resin Package (URP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVU307	7	URP

Outline





1. Cathode
2. Anode

Hitachi semiconductor

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	32	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	–55 to +125	°C

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I_{R1}	—	—	10	nA	V_R = 30V
	I_{R2}	—	—	100		V_R = 30V, Ta= 60°C
Capacitance	C_2	32.2	—	37.5	pF	V_R = 2V, f = 1MHz
	C_{25}	2.57	—	3.00		V_R = 25V, f = 1MHz
Capacitance ratio	n	12.0	12.5	—	—	C_2/C_{25}
Series resistance	r_S	—	—	0.85	Ω	V_R = 5V, f = 470MHz
Matching error	ΔC/C*[1]	—	—	2.0	%	V_R = 2 to 25V, f = 1 MHz

Note 1. C.C system (Continuous Connected taping system) enable to make any 10 pcs of ΔC/C continuous in a reel , expect extention to another group.
Calculate Matching Error,

$$\Delta C/C = \frac{(Cmax-Cmin)}{Cmin} \times 100\ (\%)$$

Main Characteristic

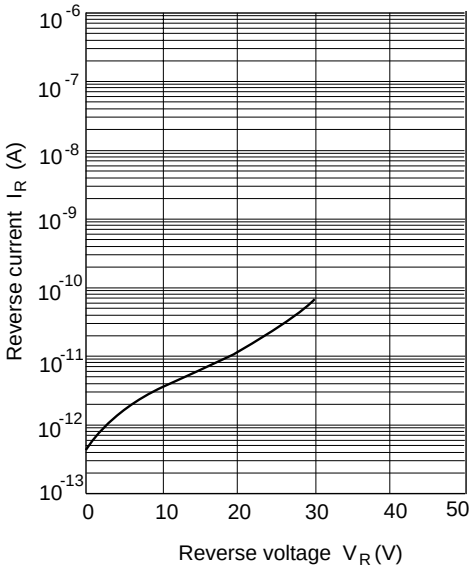


Fig.1 Reverse current Vs. Reverse voltage

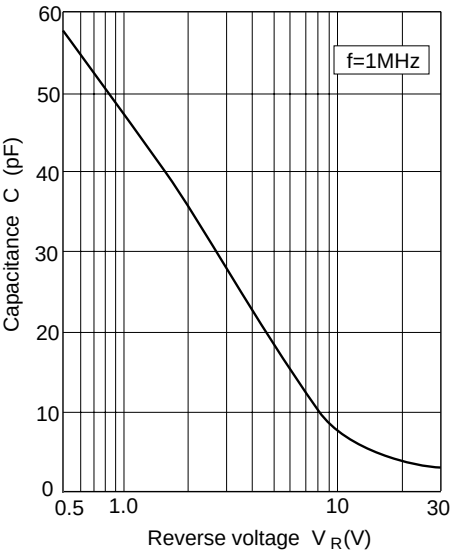


Fig.2 Capacitance Vs. Reverse voltage

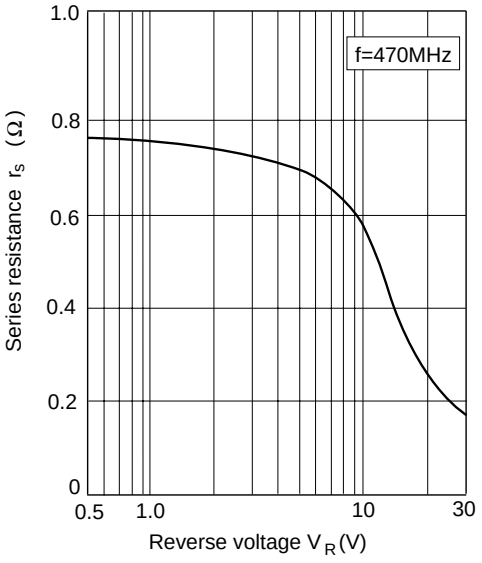


Fig.3 Series resistance Vs. Reverse voltage

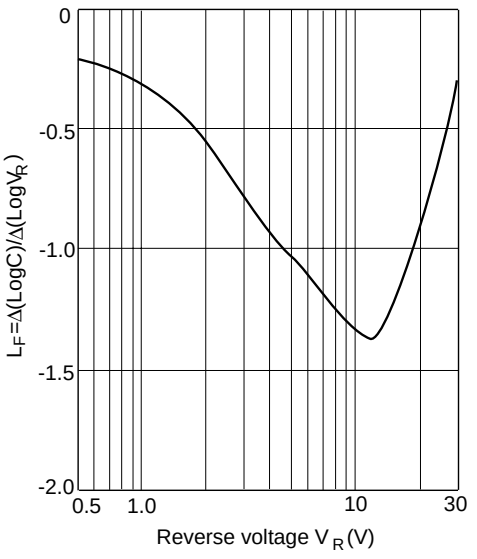
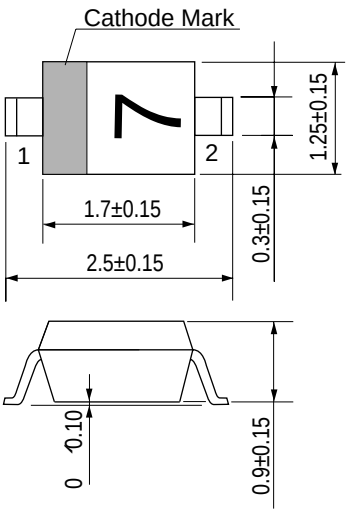


Fig.4 Linearity factor Vs. Reverse voltage

Package Dimensions

Unit : mm





1. Cathode
2. Anode

Hitachi Code	*URP*
JEDECCode	—
EIAJCode	—
Weight(g)	0.004

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